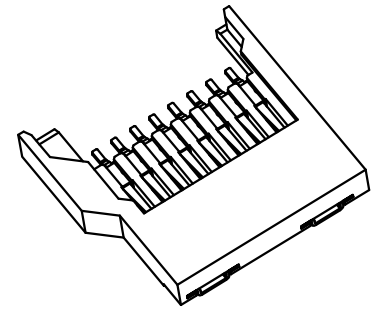
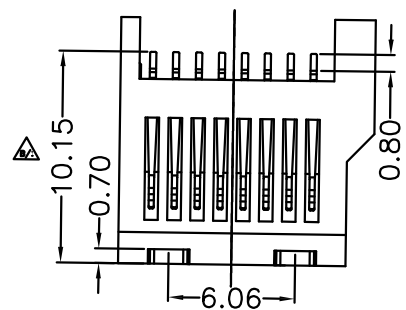
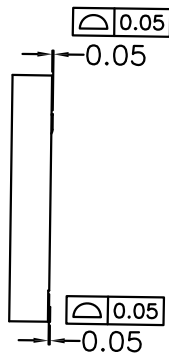
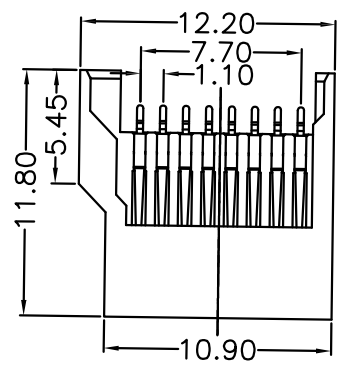
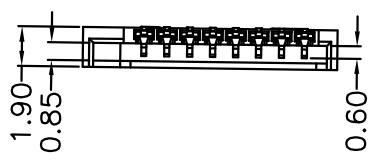


REV.	ECN.NO.	APPD.
A	/	/



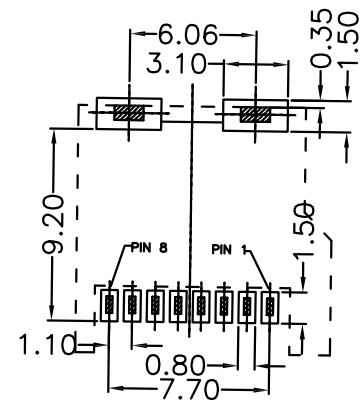
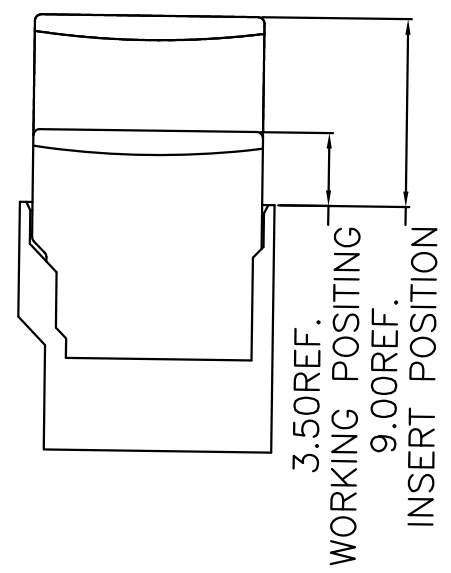
**\*Electrical Characteristics:**  
 Contact Current Rating:0.5 Amperes.  
 Dielectric Withstanding Voltage:AC500V r.m.s.  
 Insulation Resistance:1000 MΩ Minimum.  
 Contact Resistance:100 mΩ Maximum.

**\*Environmental:**  
 Operating Temperature:-25°C~+90°C.

**\*Environmental:**  
 Mating Cycles:5000~10,000 Insertions.

**\*Mechanical Characteristics:**  
 Card Push Insertion/Out Force:1.4kgf. MAX  
 Contact Separation Force:0.20kgf Minimum.

**\*Material:**  
 Insulator:HI-Temp Plastic UL 94V-0 Rated.  
 Contact:Copper Alloy(t=0.15mm).  
 Shell:Stainless Steel(t=0.20mm).  
 Spring:SWP.



RECOMMENDED P.C.B HOLE LAYOUT  
 COMPONENT SIDE VIEW(TOLERANCE:  
 +/-0.05)

SD5209-071-G618  
 G:半金G/Fu”  
 1:黑色  
 6:LCP

PIN NO.	NAME
1	DAT2
2	CD/DAT3
3	CMD
4	VDD
5	CLX
6	VSS
7	DAT0
8	DAT1

TOLERANCE UNLESS OTHERWISE SPECIFIED		FLW 深圳市华联威电子科技有限公司				
.XXX ±0.10	.X' ±3'	HUA LIAN WEI TECHNOLOGY ELECTRONICS CO;LTD.				
.XX ±0.20	.XX' ±2'	APPROVED	PART NAME:	T-FLASH 简易全塑卡座		
.X ±0.30		CHECKED	PART No:	SD5209-071-G618	C	
DRAWN	weihong	PROJECTION:	UNIT:	SCALE	SHEET	REV.
DATE	2021.7.23		mm	1:1	10F1	A